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(74) Common Representative: **DEGUSSA AG**; Intellectual  
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(71) Applicant (*for all designated States except US*): **DE-  
GUSSA AG** [DE/DE]; Bennigsenplatz 1, 40474 Düssel-  
dorf (DE).

(72) Inventors; and

(75) Inventors/Applicants (*for US only*): **MÜH, Ekkehard**  
[DE/DE]; Oberrheinplatz 4, 79618 Rheinfelden (DE).  
**RAULEDER, Hartwig** [DE/DE]; Uhlandweg 51 a,  
79618 Rheinfelden (DE). **KLEIN, Harald** [DE/DE]; Im  
Erlengrund 3, 63864 Glatbach (DE). **MONKIEWICZ,**  
**Jaroslav** [PL/DE]; Burstelstrasse 2 a, 79618 Rheinfelden  
(DE). **SAVVOPOULOS, Iordanis** [GR/DE]; Beethoven-  
strasse 7, 65812 Bad Soden am Taunus (DE).

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(54) Title: **SILICON COMPOUNDS FOR PRODUCING SiO<sub>2</sub>-CONTAINING INSULATING LAYERS ON CHIPS**

(57) Abstract: The present invention relates to a process for producing an SiO<sub>2</sub>-containing insulating layer on chips and the use of specific precursors for this purpose. The invention further relates to an insulating layer obtainable in this way and also to chips which have been provided with such an insulating layer.

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